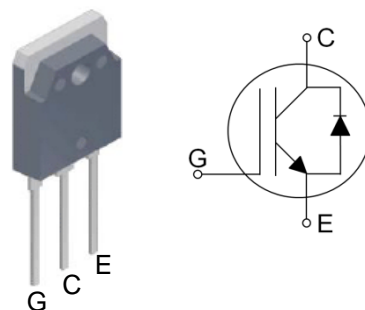


Features:

- 1350V Field Stop Trench Technology
- High Speed Switching
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy Parallel Operation
- RoHS Compliant
- JEDEC Qualification



Applications :

Induction Heating, Soft Switching Application, UPS, Welder, Inverter

Device	Package	Marking	Remark
TGAN20N135FDL2	TO-3PN	TGAN20N135FDL2	RoHS

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-Emitter Voltage	V_{CES}	1350	V	
Gate-Emitter Voltage, Forward	V_{GES}	± 25	V	
Continuous Collector Current	I_c	$T_C = 25\text{ }^\circ\text{C}$	40	A
		$T_C = 100\text{ }^\circ\text{C}$	20	A
Pulsed Collector Current (Note 1)	I_{CM}	100	A	
Diode Continuous Forward Current	I_F	20	A	
Power Dissipation	P_D	$T_C = 25\text{ }^\circ\text{C}$	223	W
		$T_C = 100\text{ }^\circ\text{C}$	86	W
Operating Junction Temperature	T_{vj}	-55 ~ 150	$^\circ\text{C}$	
Storage Temperature Range	T_{STG}	-55 ~ 150	$^\circ\text{C}$	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$	

Notes :

- (1) Repetitive rating : Pulse width limited by maximum junction temperature , During production, high current switching capability is 100% verified with the inductive load single-pulse switching test. ($I_c=100\text{A}$)

Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.56	$^\circ\text{C/W}$
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	3	$^\circ\text{C/W}$
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$

Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Units
OFF						
Collector – Emitter Breakdown Voltage	BV_{CES}	$V_{GE} = 0V, I_C = 1mA$	1350	--	--	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE} = 1350V, V_{GE} = 0V$	--	--	1	mA
Forward Gate – Emitter Leakage Current	$I_{GES(F)}$	$V_{CE} = 0V, V_{GE} = \pm 25V$	--	--	± 500	nA

ON

Gate – Emitter Threshold Voltage	$V_{GE(TH)}$	$V_{GE} = V_{CE}, I_C = 20mA$	4.0	6.0	8.0	V
Collector – Emitter Saturation Voltage	$V_{CE(SAT)}$	$V_{GE} = 15V, I_C = 20A, T_{vj} = 25^{\circ}\text{C}$	1.5	1.8	2.2	V
		$V_{GE} = 15V, I_C = 20A, T_{vj} = 125^{\circ}\text{C}$	--	2.2	--	V

DYNAMIC

Input Capacitance	C_{IES}	$V_{CE} = 30V,$ $V_{GE} = 0V$ $f = 1MHz$	--	1950	--	pF
Output Capacitance	C_{OES}		--	55	--	pF
Reverse Transfer Capacitance	C_{RES}		--	40	--	pF

SWITCHING

Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 20A$ $R_G = 10\Omega, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^{\circ}\text{C}$	--	25	--	ns
Rise Time	t_r		--	30	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	175	--	ns
Fall Time	t_f		--	105	155	ns
Turn-On Switching Loss	E_{ON}		--	2.5	3.7	mJ
Turn-Off Switching Loss	E_{OFF}		--	0.76	1.15	mJ
Total Switching Loss	E_{TS}		--	3.26	4.85	mJ
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 20A$ $R_G = 10\Omega, V_{GE} = 15V$ Inductive Load, $T_{vj} = 125^{\circ}\text{C}$	--	25	--	ns
Rise Time	t_r		--	30	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	190	--	ns
Fall Time	t_f		--	235	--	ns
Turn-On Switching Loss	E_{ON}		--	2.5	3.7	mJ
Turn-Off Switching Loss	E_{OFF}		--	1.52	2.28	mJ
Total Switching Loss	E_{TS}		--	4.02	5.98	mJ
Total Gate Charge	Q_g	$V_{CC} = 600V, I_C = 20A$ $V_{GE} = 15V$	--	120	180	nC
Gate-Emitter Charge	Q_{ge}		--	15	20	nC
Gate-Collector Charge	Q_{gc}		--	60	90	nC

Electrical Characteristics of the DIODE $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Units	
Diode Forward Voltage	V_{FM}	$I_F = 20\text{A}$	$T_{vj} = 25^{\circ}\text{C}$	--	2.4	2.8	V
			$T_{vj} = 125^{\circ}\text{C}$	--	2.75	--	
Reverse Recovery Time	t_{rr}	$I_F = 20\text{A},$ $di/dt = 200\text{A}/\mu\text{s}$	$T_{vj} = 25^{\circ}\text{C}$	--	265	425	ns
			$T_{vj} = 125^{\circ}\text{C}$	--	295	--	
Reverse Recovery Current	I_{rr}		$T_{vj} = 25^{\circ}\text{C}$	--	23	35	A
			$T_{vj} = 125^{\circ}\text{C}$	--	28.5	--	
Reverse Recovery Charge	Q_{rr}		$T_{vj} = 25^{\circ}\text{C}$	--	3030	6000	nC
			$T_{vj} = 125^{\circ}\text{C}$	--	4170	--	

IGBT Characteristics

Fig. 1 IGBT Output Characteristics

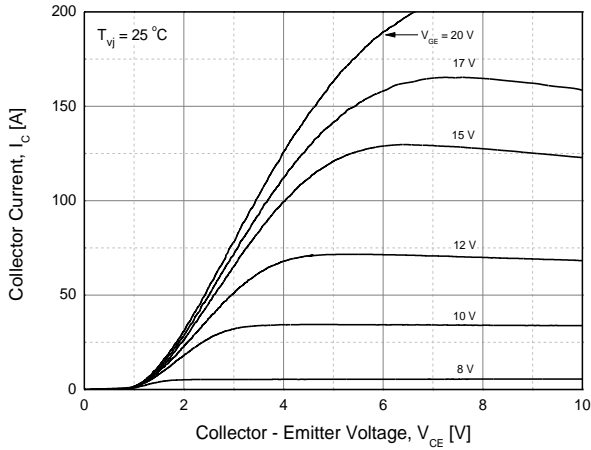


Fig. 2 IGBT Saturation Voltage Characteristics

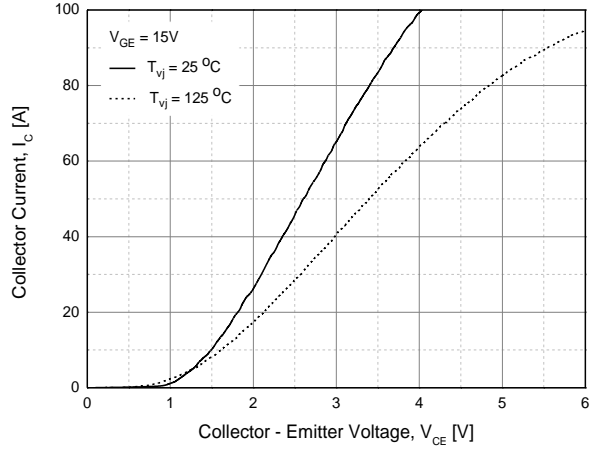


Fig. 3 IGBT Saturation Voltage vs. Junction Temperature

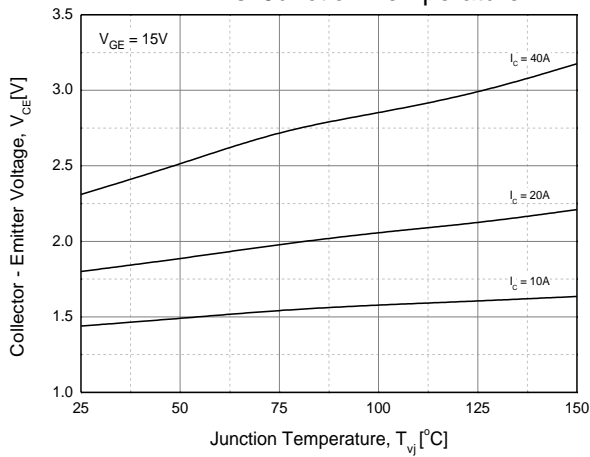


Fig. 4 IGBT Saturation Voltage vs. Gate Bias

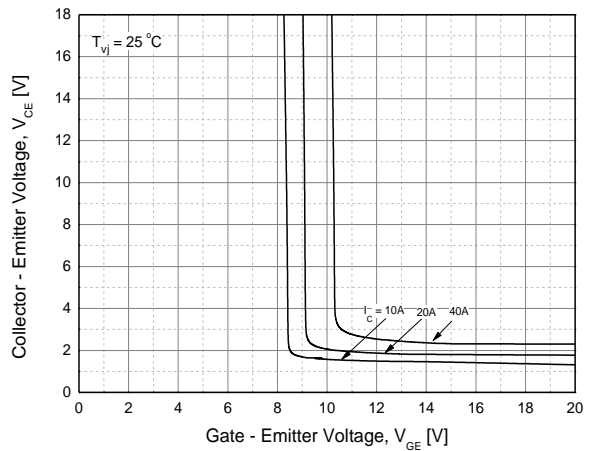


Fig. 5 IGBT Saturation Voltage vs. Gate Bias

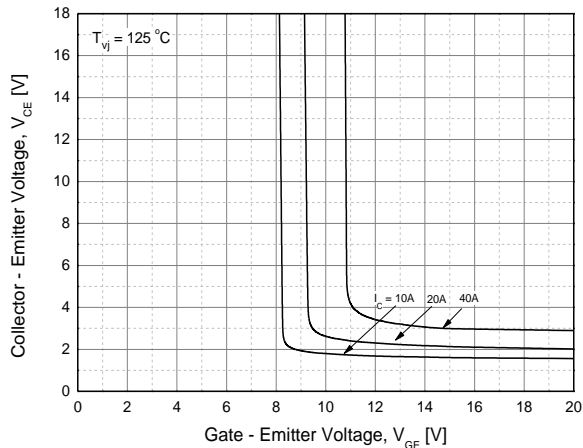
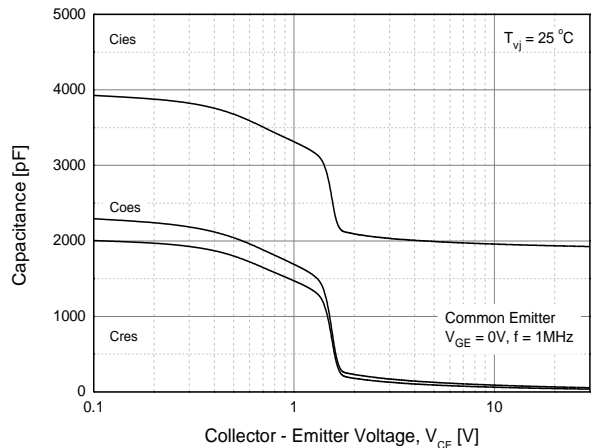


Fig. 6 Capacitance Characteristics



IGBT Characteristics

Fig. 7 Turn-on Time vs. Gate Resistor

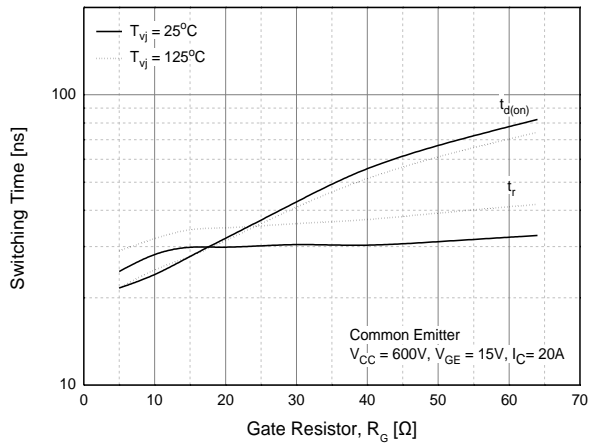


Fig. 8 Turn-off Time vs. Gate Resistor

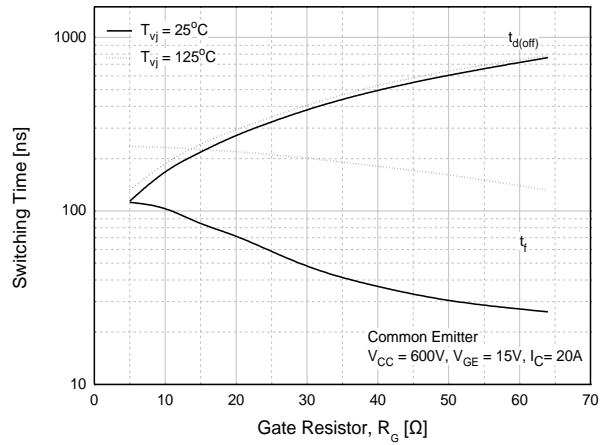


Fig. 9 Switching Loss vs. Gate Resistor

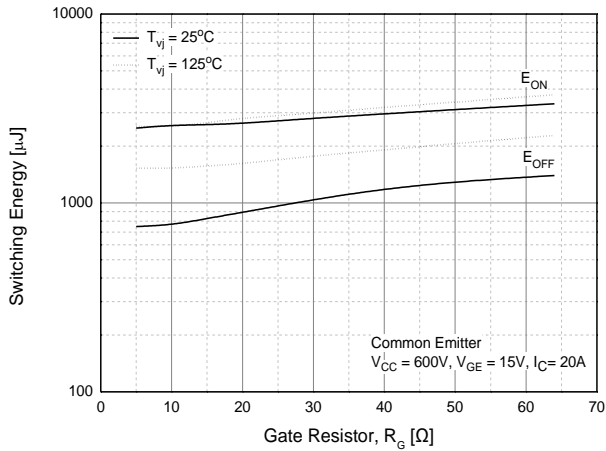


Fig. 10 Turn-on Time vs. Collector Current

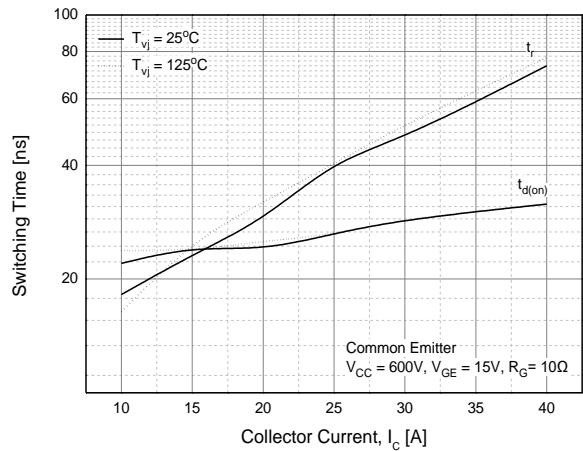


Fig. 11 Turn-off Time vs. Collector Current

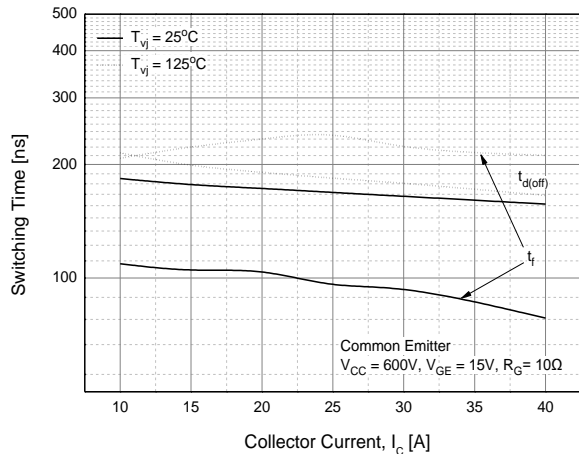
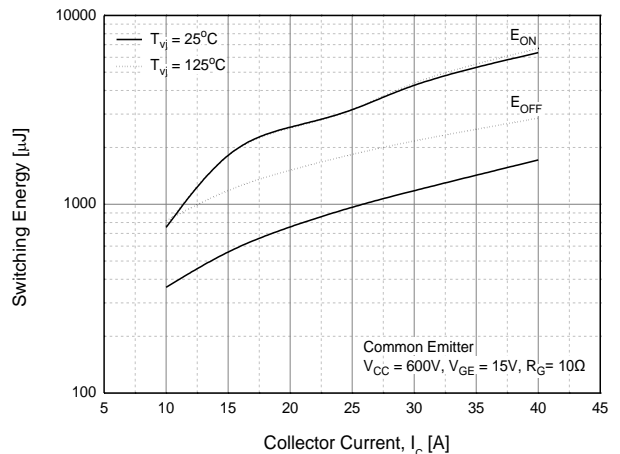


Fig. 12 Switching Loss vs. Collector Current



IGBT Characteristics

Fig. 13 Gate Charge Characteristics

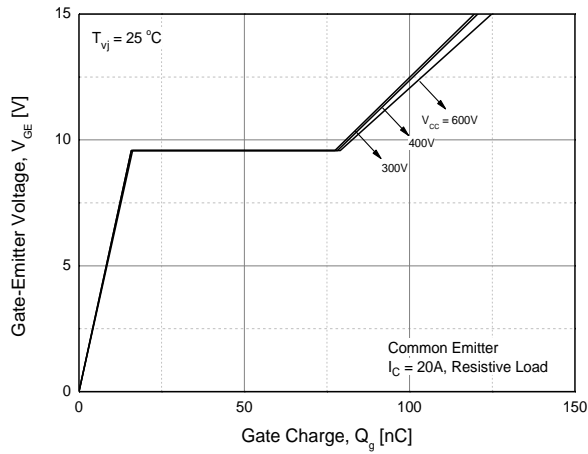


Fig. 14 SOA

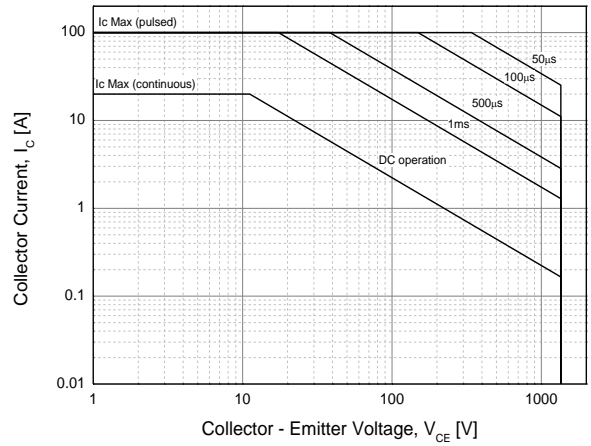


Fig. 15 RBSOA

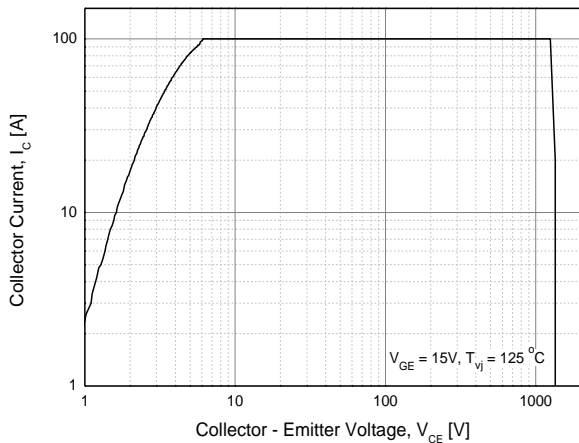


Fig. 16 Transient Thermal Impedance of IGBT

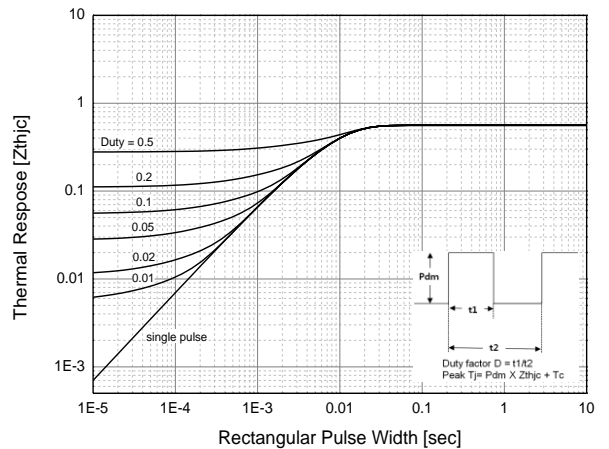


Fig. 17 Load Current vs. Frequency

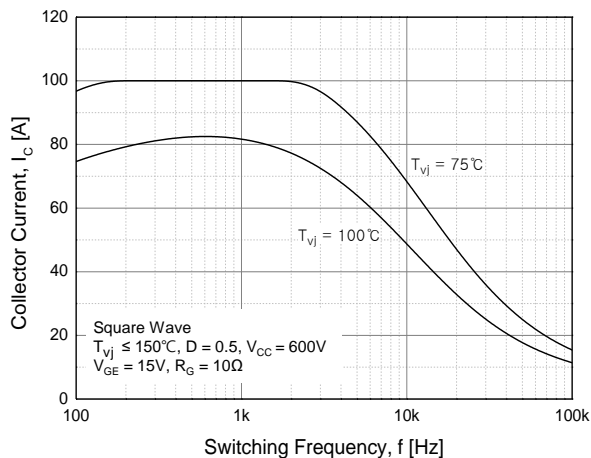
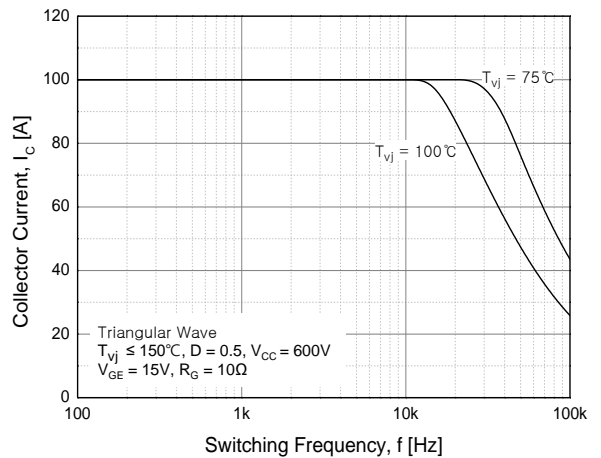


Fig. 18 Load Current vs. Frequency



Diode Characteristics

Fig. 19 Diode Conduction Characteristics

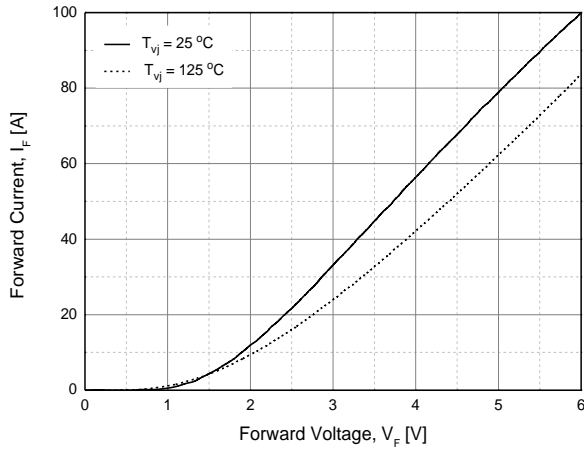


Fig. 20 Reverse Recovery Current vs. Forward Current

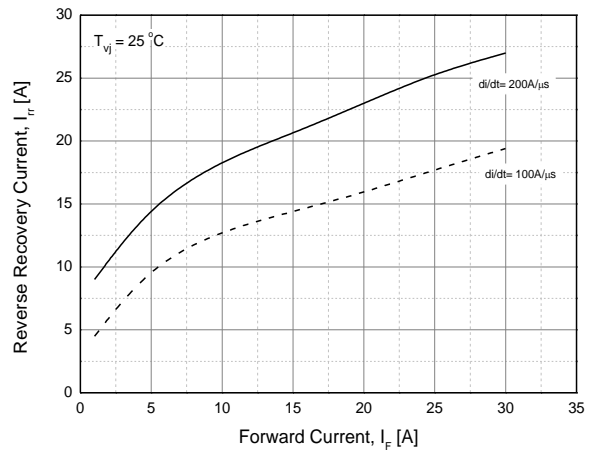


Fig. 21 Reverse Recovery Charge vs. Forward Current

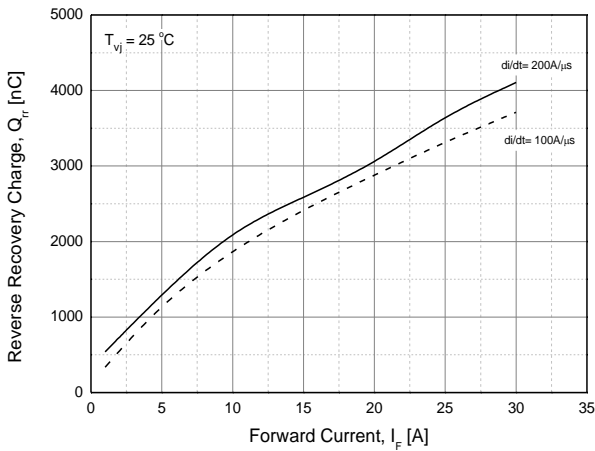
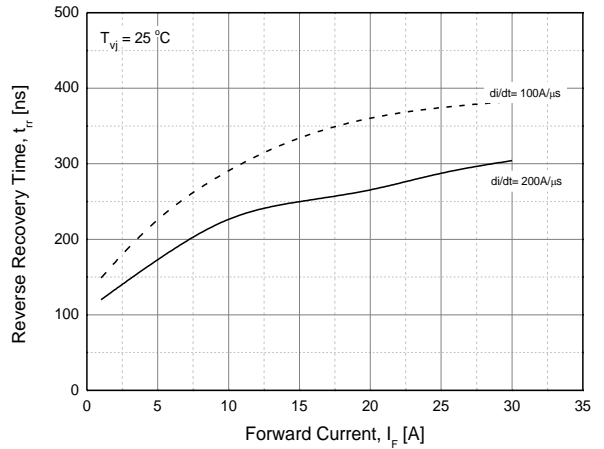
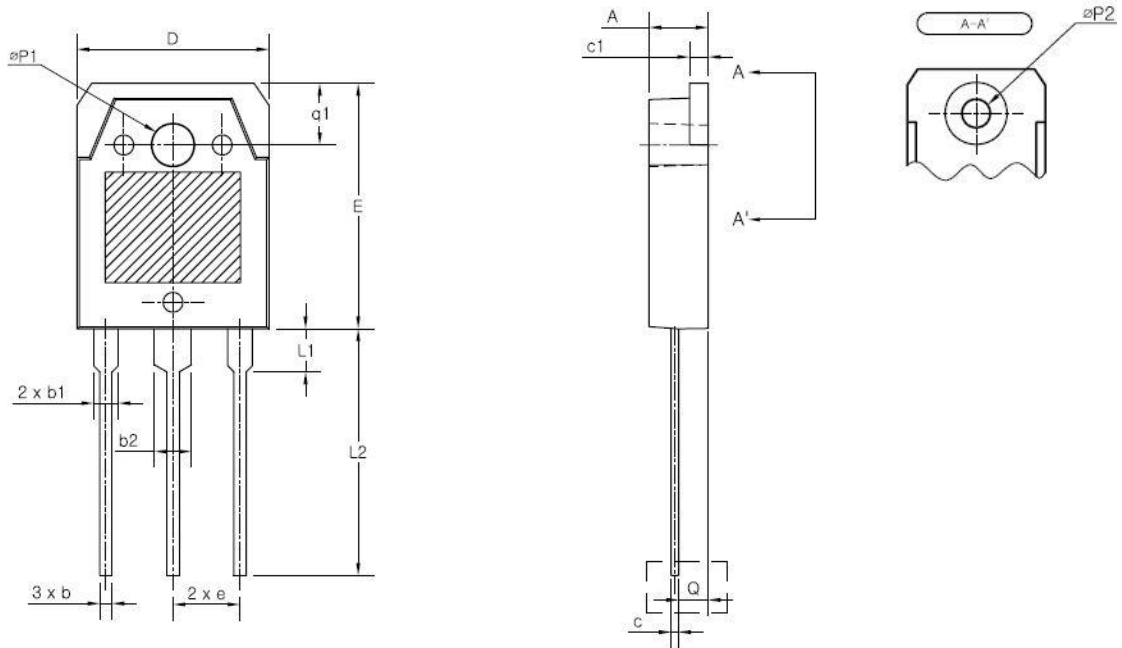


Fig. 22 Reverse Recovery Time vs. Forward Current



TO-3PN MECHANICAL DATA



SYMBOL	mm		
	MIN	NOM	MAX
A	4.60	4.80	5.00
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
c	0.55	0.60	0.75
c1	1.45	1.50	1.65
D	15.40	15.60	15.80
E	19.20	19.65	20.10
e	5.15	5.45	5.75
L1	3.30	3.50	3.70
L2	19.80	20.00	20.20
ϕP1	3.30	3.40	3.50
ϕP2	(3.20)		
Q	2.20	2.40	2.60
q1	4.80	5.00	5.20

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